Content SD2942

#### **Content**

| 1 | Electrical data 3            |
|---|------------------------------|
|   | 1.1 Maximum rating 3         |
|   | 1.2 Thermal data 3           |
| 2 | Electrical characteristics 4 |
| 3 | Impedance 5                  |
| 4 | Typical performance 6        |
| 5 | Test circuit                 |
| 6 | Package mechanical data      |
| 7 | Revision history             |

SD2942 Electrical data

#### 1 Electrical data

#### 1.1 Maximum rating

 $T_{CASE} = 25^{\circ} C$ 

Table 2. Absolute maximum rating

| Symbol                              | Parameter                                  | Value       | Unit |
|-------------------------------------|--|-------------|------|
| V <sub>(BR)DSS</sub> <sup>(1)</sup> | Drain source voltage                       | 130         | V    |
| V <sub>DGR</sub> <sup>(1)</sup>     | Drain-gate voltage ( $R_{GS} = 1M\Omega$ ) | 130         | V    |
| V <sub>GS</sub>                     | Gate-source voltage                        | ±20         | V    |
| I <sub>D</sub>                      | Drain current                              | 40          | Α    |
| P <sub>DISS</sub>                   | Power dissipation                          | 500         | W    |
| TJ                                  | Max. operating junction temperature        | +200        | °C   |
| T <sub>STG</sub>                    | Storage temperature                        | -65 to +150 | °C   |

<sup>1.</sup>  $T_J = 150 \, ^{\circ}C$ 

#### 1.2 Thermal data

Table 3. Thermal data

| Symbol            | Parameter                           | Value | Unit  |
|-------------------|-------------------------------------|-------|-------|
| R <sub>thJC</sub> | Junction to case thermal resistance | 0.35  | ° C/W |

Electrical characteristics SD2942

## 2 Electrical characteristics

 $T_{CASE} = 25^{\circ}C$ 

Table 4. Static (per section)

| Symbol                              |                         | Test conditions           | Min.      | Тур. | Max. | Unit |     |
|-------------------------------------|-------------------------|---------------------------|-----------|------|------|------|-----|
| V <sub>(BR)DSS</sub> <sup>(1)</sup> | $V_{GS} = 0 V$          | $I_{DS} = 100 \text{ mA}$ |           | 130  |      |      | V   |
| I <sub>DSS</sub>                    | $V_{GS} = 0 V$          | $V_{DS} = 50 \text{ V}$   |           |      |      | 100  | μΑ  |
| I <sub>GSS</sub>                    | V <sub>GS</sub> = 20 V  | V <sub>DS</sub> = 0 V     |           |      |      | 250  | nA  |
| $V_{GS(Q)}$                         | V <sub>DS</sub> = 10 V  | $I_D = 250 \text{ mA}$    |           | 1.5  |      | 4    | V   |
| V <sub>DS(ON)</sub>                 | V <sub>GS</sub> = 10 V  | I <sub>D</sub> = 10 A     |           |      |      | 3.0  | V   |
| $G_{FS}$                            | $V_{DS} = 10 \text{ V}$ | I <sub>D</sub> = 5 A      |           | 5    |      |      | mho |
| C <sub>ISS</sub>                    | $V_{GS} = 0 V$          | $V_{DS} = 50 \text{ V}$   | f = 1 MHz |      | 415  |      | pF  |
| C <sub>OSS</sub>                    | $V_{GS} = 0 V$          | $V_{DS} = 50 \text{ V}$   | f = 1 MHz |      | 236  |      | pF  |
| C <sub>RSS</sub>                    | V <sub>GS</sub> = 0 V   | V <sub>DS</sub> = 50 V    | f = 1 MHz |      | 17   |      | pF  |

<sup>1.</sup>  $T_J = 150^{\circ} C$ 

Table 5. Dynamic

| Symbol           | Test Conditions   | Min. | Тур. | Max. | Unit     |
|------------------|---|------|------|------|----------|
| P <sub>OUT</sub> | $V_{DD} = 50 \text{ V}$ $I_{DQ} = 500 \text{ mA}$ $f = 175 \text{MHz}$                                  | 350  |      |      | W        |
| G <sub>PS</sub>  | $V_{DD} = 50 \text{ V}$ $I_{DQ} = 500 \text{ mA}$ $P_{OUT} = 350 \text{ W}$ $f = 175 \text{MHz}$        | 15   | 17   |      | dB       |
| η                | $V_{DD} = 50 \text{ V}$ $I_{DQ} = 500 \text{ mA}$ $P_{OUT} = 350 \text{ W}$ $f = 175 \text{MHz}$        | 55   | 61   |      | %        |
| Load<br>Mismatch | $V_{DD} = 50 \text{ V}$ $I_{DQ} = 500 \text{ mA}$ $P_{OUT} = 350 \text{ W}$ f = 175MHz all phase angles | 5:1  |      |      | VSW<br>R |

SD2942 Impedance

## 3 Impedance

Figure 2. Impedance data schematic

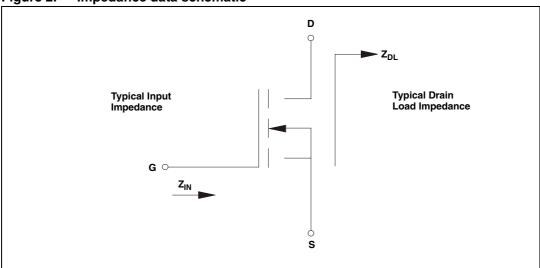


Table 6. Impedance data

| f       | <b>Z</b> <sub>IN</sub> (Ω) | <b>Z</b> <sub>DL</sub> (Ω) |
|---------|----------------------------|----------------------------|
| 250 MHz | 1.3 - j 1.9                | 1.9 + j 3.2                |
| 230 MHz | 1.2 - j 1.8                | 2.1 + j 3.7                |
| 200 MHz | 1.1 - j 1.6                | 2.7 +j 4.2                 |
| 175 MHz | 1.0 - j 1.4                | 3.3 + j 4.8                |
| 100 MHz | 1.8 - j 2.5                | 7.5 + j 9                  |
| 50 MHz  | 3.2 - j 4.4                | 10 + j 12                  |

## 4 Typical performance

Figure 3. Capacitance vs drain voltage

1000 Coss
100 CRSS
10 5 10 15 20 25 30 35 40 45 50 55
Vdd (V)

Figure 4. Drain current vs gate voltage

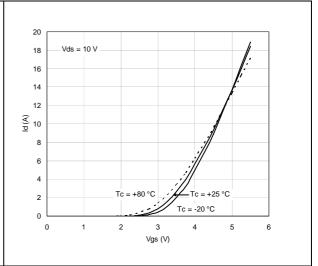


Figure 5. Gate-source voltage vs case temperature

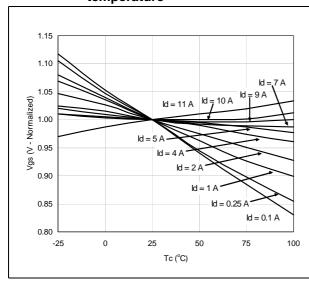
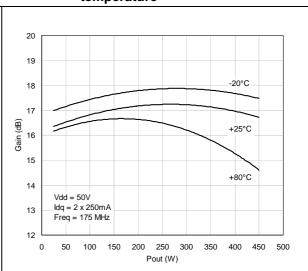


Figure 6. Power gain vs Pout and case temperature

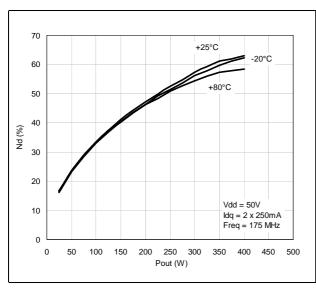


6/16 Doc ID 11736 Rev 3

SD2942 Typical performance

Figure 7. Efficiency vs case temperature

Figure 8. Pout vs input power and case temperature



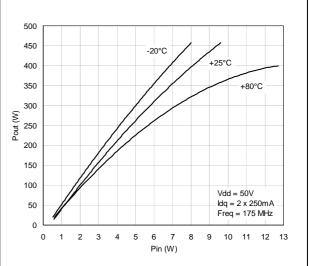
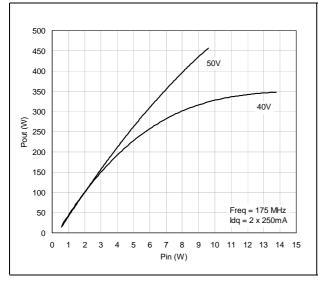
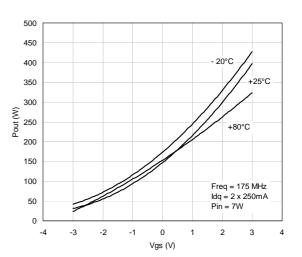


Figure 9. Pout vs input power and drain voltage

Figure 10. Pout vs gate voltage and case temperature

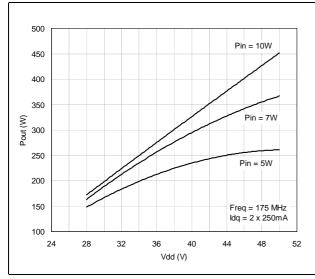




Typical performance SD2942

Figure 11. Pout vs drain voltage and input power

Figure 12. Maximum thermal resist vs case temperature



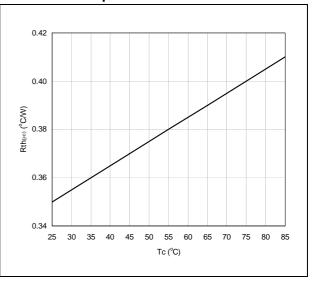
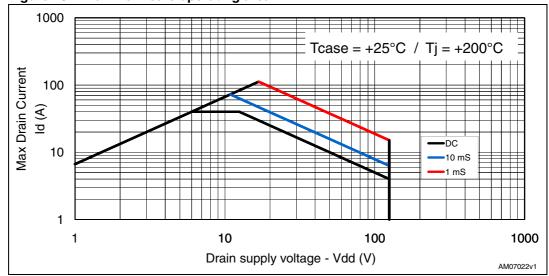


Figure 13. Maximum safe operating area



8/16 Doc ID 11736 Rev 3

SD2942 Typical performance

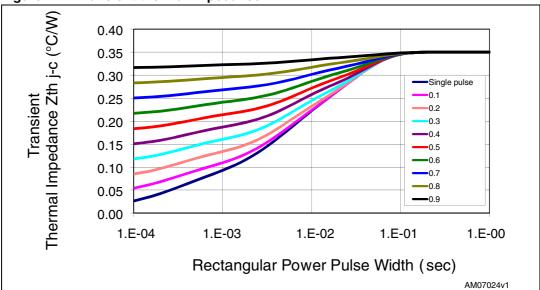
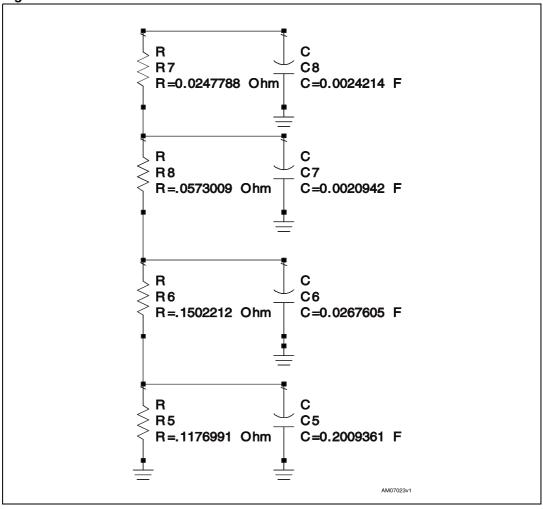


Figure 14. Transient thermal impedance





4

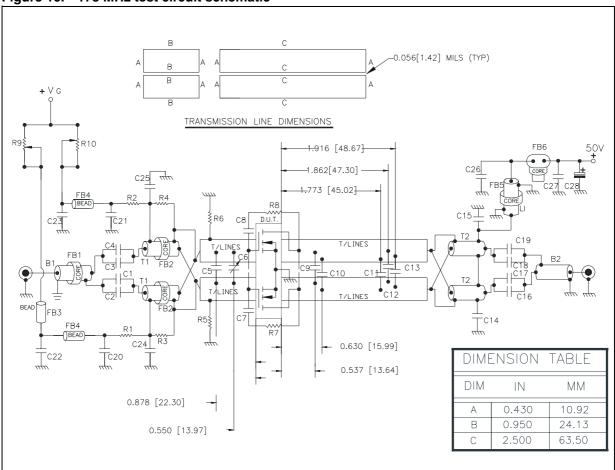
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9/16

Test circuit SD2942

#### 5 Test circuit

Figure 16. 175 MHz test circuit schematic



Note: 1 Dimension at component symbol are reference for component placement.

2 Gap between ground and transmission lines is  $+ 0.002\{0.05\} - 0.000\{0.00\}$  Typ.

SD2942 Test circuit

Table 7. 175 MHz test circuit component part list

| Symbol                      | Description   |
|-----------------------------|---|
| R1,R2,R5,R6                 | 470 Ω1 W, surface mount chip resistor   |
| R3,R4                       | 360 $\Omega$ 0.5 W, carbon comp. axial lead resistor or equivalent  |
| R7,R8                       | 560 Ω2 W, resistor two turn wire air-wound axial lead resistor  |
| R9,R10                      | 20 KΩ 3.09 W, 10 turn wirewound precision potentiometer   |
| C1,C4                       | 680 pF ATC 130B surface mount ceramic chip capacitor  |
| C2,C3,C7,C8,C17,C19,C20,C21 | 10000 pF ATC 200B surface mount ceramic chip capacitor  |
| C5                          | 75 pF ATC 100B surface mount ceramic chip capacitor   |
| C6                          | ST40 25 pF - 115 pF miniature variable trimmer  |
| C9,C10                      | 47 pF ATC 100B surface mount ceramic chip capacitor   |
| C11,C12, C13                | 43 pF ATC 100B surface mount ceramic chip capacitor   |
| C14,C15,C24,C25             | 1200 pF ATC 700B surface mount ceramic chip capacitor   |
| C16,C18                     | 470 pF ATC 700B surface mount ceramic chip capacitor  |
| C22,C23                     | 0.1 μF / 500 V surface mount ceramic chip capacitor   |
| C26,C27                     | 0.01 μF / 500 V surface mount ceramic chip capacitor  |
| C28                         | 10 μF / 63 aluminum electrolytic axial lead capacitor   |
| B1                          | $50~\Omega\text{RG}316~\text{O.D}~0.076[1.93]~\text{L}$ = 11.80[299.72] flexible coaxial cable 4 turns thru fair-rite bead                        |
| B2                          | $50 \Omega$ RG-142B O.D 0.165[4.19] L = 11.80[299.72] flexible coaxial cable  |
| Т1                          | R.F. transformer 4:1, 25 $\Omega$ O.D RG316-25 O.D 0.080[2.03] L = 5.90[149.86] flexible coaxial cable 2 turns thru fair-rite multi-aperture core |
| Т2                          | R.F. transformer 1:4, 25 $\Omega$ semi-rigid coaxial cable O.D. 0.141[3.58] L = 5.90[149.86]  |
| L1                          | Inductor $\lambda$ 1/4 wave 50 $\Omega$ O.D 0.165[4.19] L = 11.80 [299.72] flexible coaxial cable 2 turns thru fair-rite bead                     |
| FB1,FB5                     | Shield bead   |
| FB2,FB6                     | Multi-aperture core   |
| FB3                         | Multilayer ferrite chip bead (surface mount)  |
| FB4                         | Surface mount emi shield bead   |
| PCB                         | Woven glass reinforced ptfe microwave Laminate 0.06", 1 oz EDCu, both sides, $\epsilon r = 2.55$  |

Test circuit SD2942

Figure 17. 175 MHz test circuit photomaster

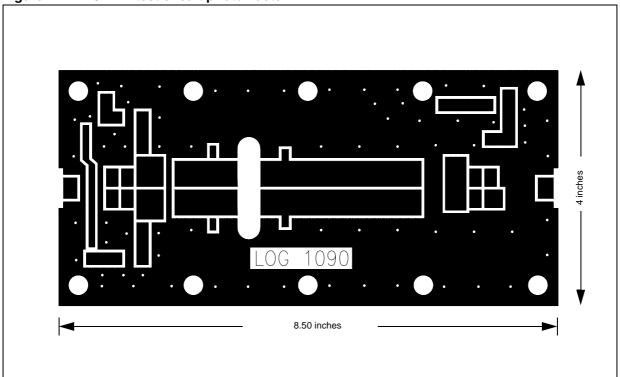
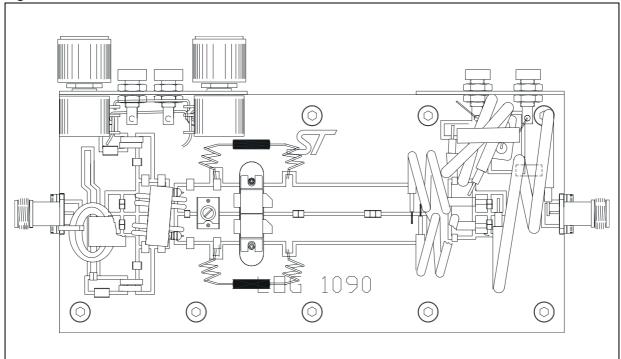


Figure 18. 175 MHz test circuit



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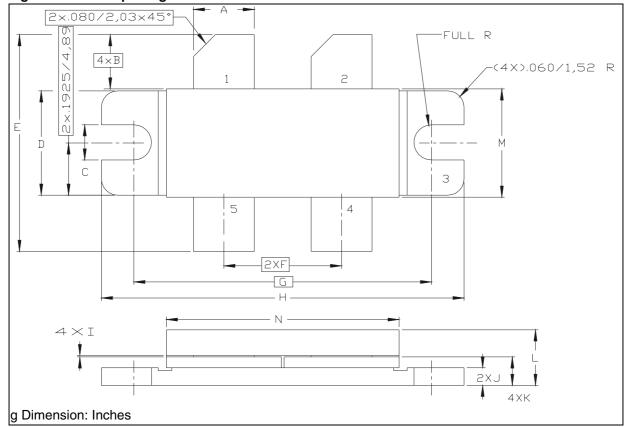
## 6 Package mechanical data

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Table 8. M244 (.400 x .860 4/L BAL N/HERM W/FLG)

| DIM. |       | mm.   |       |       | inch  |       |
|------|-------|-------|-------|-------|-------|-------|
|      | Min.  | Тур.  | Max.  | Min.  | Тур.  | Max.  |
| Α    | 5.59  |       | 5.84  | 0.220 |       | 0.230 |
| В    |       | 5.08  |       |       | 0.200 |       |
| С    | 3.02  |       | 3.28  | 0.119 |       | 0.129 |
| D    | 9.65  |       | 9.91  | 0.380 |       | 0.390 |
| Е    | 19.81 |       | 20.82 | 0.780 |       | 0.820 |
| F    | 10.92 |       | 11.18 | 0.430 |       | 0.440 |
| G    |       | 27.94 |       |       | 1.100 |       |
| Н    | 33.91 |       | 34.16 | 1.335 |       | 1.345 |
| I    | 0.10  |       | 0.15  | 0.004 |       | 0.006 |
| J    | 1.52  |       | 1.78  | 0.060 |       | 0.070 |
| К    | 2.59  |       | 2.84  | 0.102 |       | 0.112 |
| L    | 4.83  |       | 5.84  | 0.190 |       | 0.230 |
| М    | 10.03 |       | 10.34 | 0.395 |       | 0.407 |
| N    | 21.59 |       | 22.10 | 0.850 |       | 0.870 |

Figure 19. M244 package dimensions



SD2942 Revision history

# 7 Revision history

Table 9. Document revision history

| Date        | Revision | Changes                                   |
|-------------|----------|---|
| 18-Oct-2005 | 1        | First Issue.                              |
| 04-Jan-2006 | 2        | Complete version.                         |
| 14-Apr-2010 | 3        | Added Figure 13, Figure 14 and Figure 15. |

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